

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIII)

TPC6104

Notebook PC Applications Portable Equipment Applications

• Low drain-source ON resistance: RDS (ON) = 33 m Ω (typ.)

• High forward transfer admittance: $|Y_{fs}| = 12 S$ (typ.)

• Low leakage current: $IDSS = -10 \mu A (max) (VDS = -20 V)$

• Enhancement mode: $V_{th} = -0.5$ to -1.2 V ($V_{DS} = -10$ V, $I_D = -200$ μA)

Maximum Ratings (Ta = 25°C)

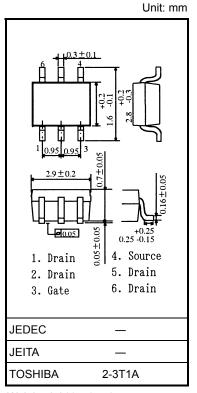
Character	istics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-20	V	
Drain-gate voltage (R	$GS = 20 \text{ k}\Omega$)	V_{DGR}	-20	V	
Gate-source voltage		V _{GSS}	±8	V	
Drain ourrent	DC (Note 1)	I _D	-5.5	А	
Drain current	Pulse (Note 1)	I _{DP}	-22		
Drain power dissipation	on (t = 5 s) (Note 2a)	P_{D}	2.2	W	
Drain power dissipation	on (t = 5 s) (Note 2b)	P _D	0.7	W	
Single pulse avalanch	e energy (Note 3)	E _{AS}	4.9	mJ	
Avalanche current		I _{AR}	-2.75	Α	
Repetitive avalanche	energy (Note 4)	E _{AR}	0.22	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	ange	T _{stg}	-55~150	°C	

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

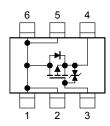
Note: Note 1, Note 2, Note 3, Note 4 and Note 5: See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 0.011 g (typ.)

Circuit Configuration



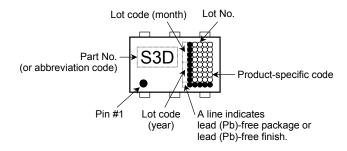
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cui	rrent	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	— — ±10		±10	μА	
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$		_	-10	μА	
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = -10$ mA, $V_{GS} = 0$ V	-20			V	
Brain-30dice bre	ardown voltage	V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 8 \text{ V}$	-12				
Gate threshold v	oltage	V _{th}	$V_{DS} = -10 \ V, \ I_D = -200 \ \mu A$	-0.5	_	-1.2	V	
		R _{DS (ON)}	$V_{GS} = -1.8 \text{ V}, I_D = -1.4 \text{ A}$		78	120		
Drain-source ON	resistance	R _{DS} (ON)	$V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$	_	49	60	mΩ	
		R _{DS} (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$	_	33	40		
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2.8 \text{ A}$	6	12	_	S	
Input capacitance		C _{iss}		_	1430	_	pF	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	200	_		
Output capacitance		C _{oss}		_	240	_		
Switching time	Rise time	t _r	V _{GS} 0 V I _D = -2.8 A O V _{OUT} C	_	8.5	_		
	Turn-on time	t _{on}		_	15	_		
	Fall time	t _f	7.7.7.00 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1	_	20	_	ns	
	Turn-off time	t _{off}	$V_{DD} \simeq -10 \text{ V}$ Duty $\leq 1\%$, $t_W = 10 \mu\text{s}$	_	66	_		
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≃ −16 V, V _{GS} = −5 V.	_	19	_		
Gate-source charge		Q _{gs}	$I_D = -5.5 \text{ A}$	_	14	_	nC	
Gate-drain ("mille	er") charge	Q _{gd}		_	5	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-22	Α
Forward voltage	(diode)	V _{DSF}	$I_{DR} = -5.5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

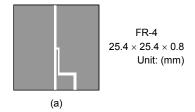
Marking (Note 5)

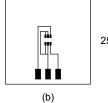


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)

(b) Device mounted on a glass-epoxy board (b) (t = 5 s)





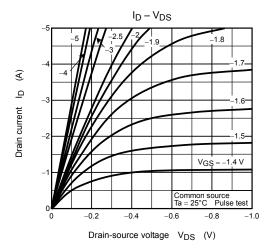
 $\begin{aligned} & \text{FR-4} \\ 25.4 \times 25.4 \times 0.8 \\ & \text{Unit: (mm)} \end{aligned}$

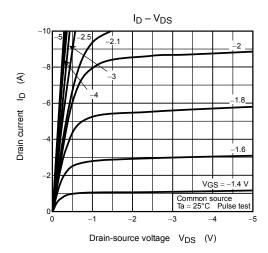
Note 3: $V_{DD} = -16 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $I_{AR} = -2.75 \text{ A}$

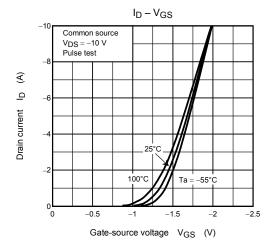
Note 4: Repetitive rating;:pulse width limited by maximum channel temperature

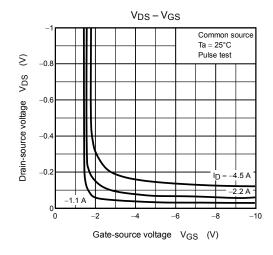
Note 5: • on lower left of the marking indicates Pin 1.

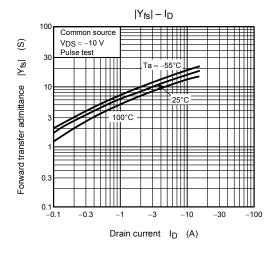
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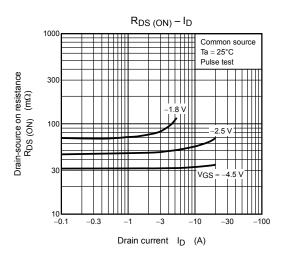


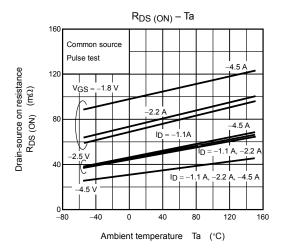


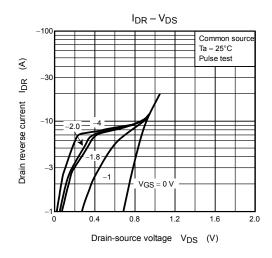


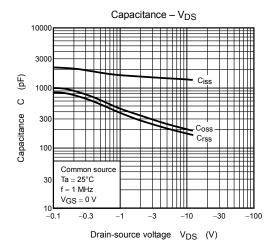


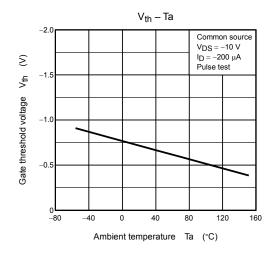


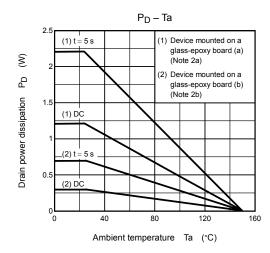


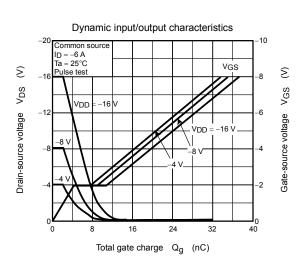




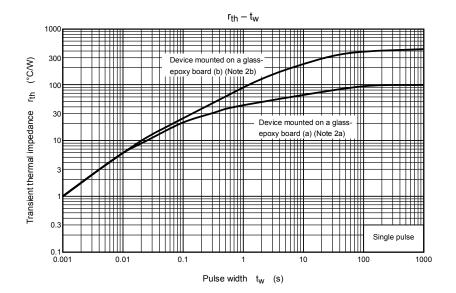


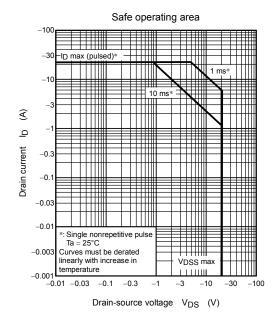






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